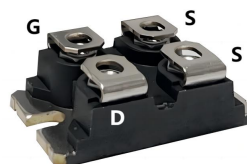


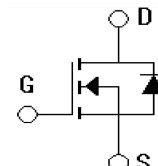
Features

- N-Channel, Low $R_{DS(on)}$
- High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated



Applications

- DC-DC Converter
- UPS
- AC Motor Drives
- Battery Chargers
- Switched-Mode and Resonant-Mode Power Supplies



Absolute Ratings ($T_c=25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	650	V
Drain Current -continuous	I_D	170	A
Drain Current - pulse*	I_{DM}	340	A
Gate-Source Voltage	V_{GS}	± 30	V
Single Pulsed Avalanche Energy	E_{AS}	5	J
Power Dissipation	PD	860	W
Operating and Storage Temperature Range	T_j, T_{STG}	$-55 \sim +150$	$^\circ\text{C}$
Maximum Lead Temperature for Soldering Purposes	T_L	300	$^\circ\text{C}$

*Drain current limited by maximum junction temperature

Electrical Characteristics($T_{CASE}=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Tests conditions	Min	Type	Max	Units
Off-Characteristics						
Drain-Source Voltage	BV_{DSS}	$I_D=3\text{mA}, V_{GS}=0\text{V}$	650	-	-	V
Drain cut-off current	I_{DSS}	$V_{DS}=650\text{V}, V_{GS}=0\text{V}$ $T_j=25^\circ\text{C}$	-	-	50	μA
Gate-body leakage current, forward	I_{GSSF}	$V_{DS}=0\text{V}, V_{GS}=30\text{V}$	-	-	200	nA
Gate-body leakage current, reverse	I_{GSSR}	$V_{DS}=0\text{V}, V_{GS}=-30\text{V}$	-	-	-200	nA

On-Characteristics						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250uA	3.0	-	5.0	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V,I _D =35A	-	18	-	mΩ
Forward transconductance	G _{fs}	V _{DS} =10V,I _D =60A	-	90	-	S
Dynamic Characteristics						
Input capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1MHz	-	25	-	nF
Output capacitance	C _{oss}		-	15	-	nF
Reverse transfer capacitance	C _{rss}		-	10	-	pF
Switching Characteristics						
Turn-On delay time	t _{d(on)}	V _{DD} =325V,I _D =85A R _g =1Ω	-	60	-	ns
Turn-On rise time	t _r		-	13	-	ns
Turn-Off delay time	T _{d(off)}		-	120	-	ns
Turn-Off Fall time	t _f		-	5	-	ns
Total Gate Charge	Q _g	V _{DS} =325V, I _D =85A, V _{GS} =10V	-	360	-	nC
Gate-Source charge	Q _{gs}		-	135	-	nC
Gate-Drain charge	Q _{gd}		-	98	-	nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =100A, (note1)	-	-	1.4	V
Maximum Continuous Drain-Source Diode Forward Current	I _S		-	170	-	A
Reverse recovery time	trr	IF=85A dIF/dt=100A/us VR=100V	-	200	-	ns
Reverse recovery charge	Qrr		-	750	-	nC

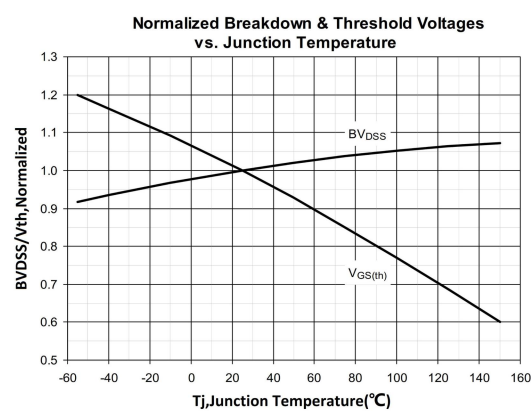
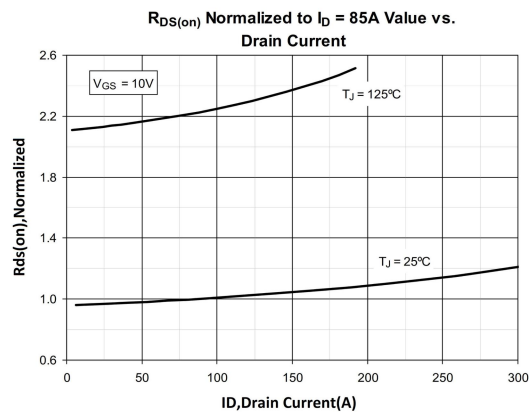
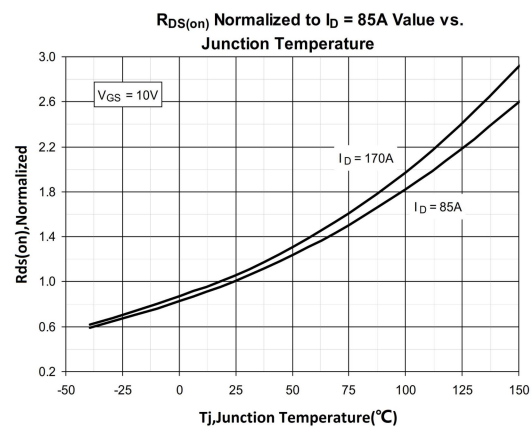
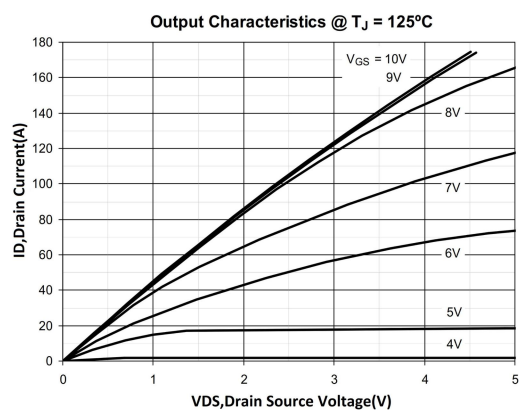
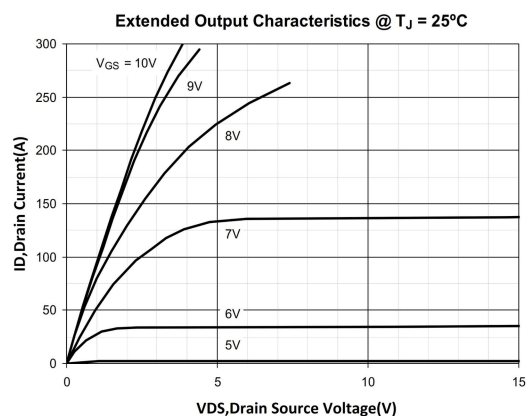
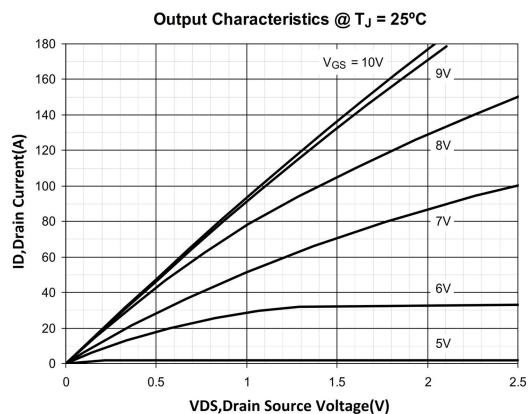
Thermal Characteristic

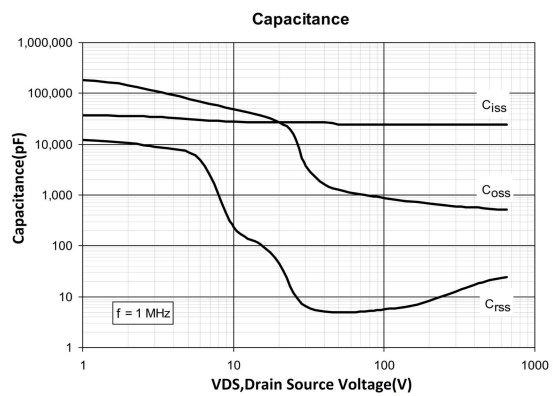
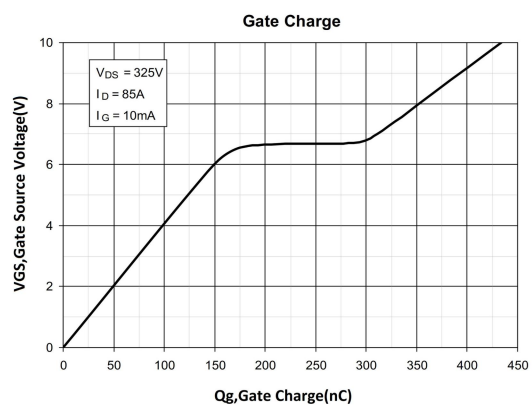
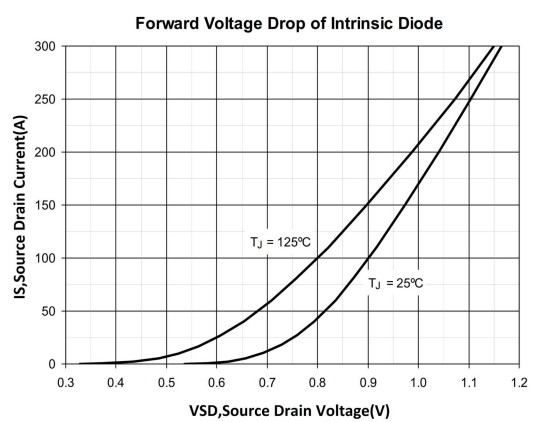
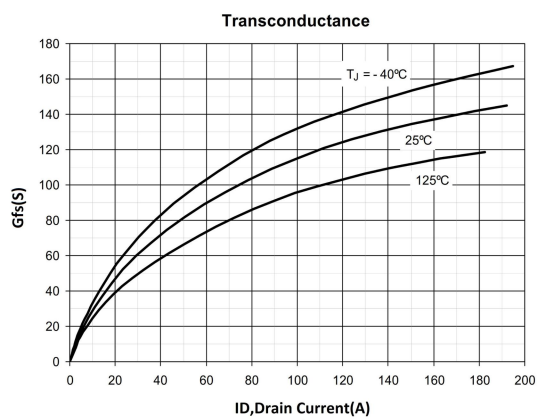
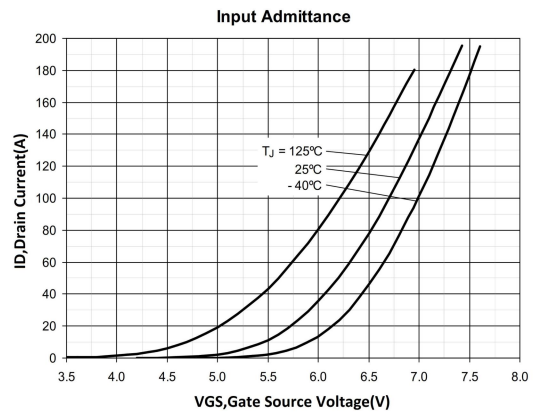
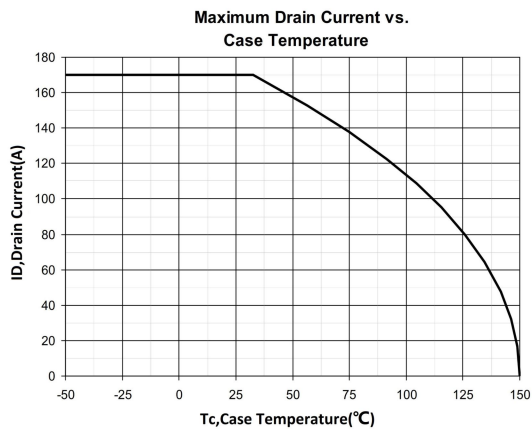
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.145	$^{\circ}C/W$

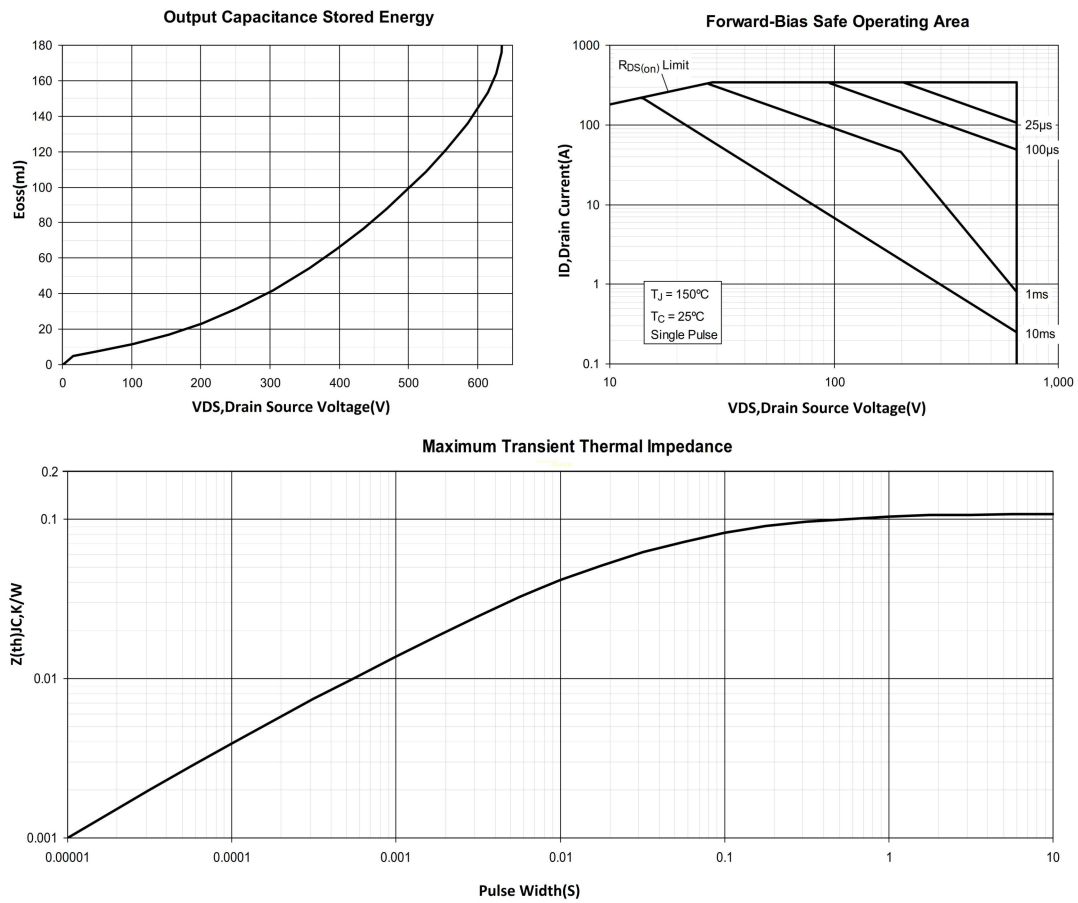
Notes:

1. Pulse test, $t \leq 300\mu s$, duty cycle, $d \leq 2\%$.

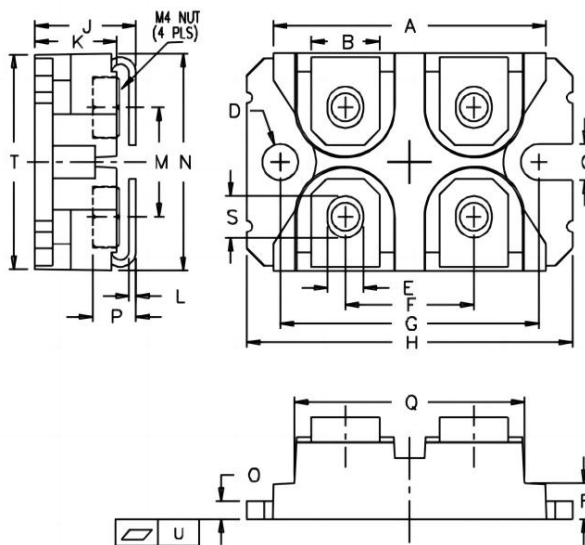
Typical Electrical and Thermal Characteristics (Curves)







Package Mechanical DATA



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004